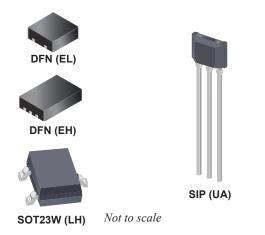


FEATURES AND BENEFITS

- AEC-Q100 automotive qualified
- Micropower operation
- Operation with north or south pole
- 2.5 to 3.5 V battery operation
- Chopper stabilized
 Superior temperature stability
 Extremely low switch point drift
 - □ Insensitive to physical stress
- High ESD protection
- Solid-state reliability
- Small size
- · Easily manufacturable with magnet pole independence

PACKAGES:



DESCRIPTION

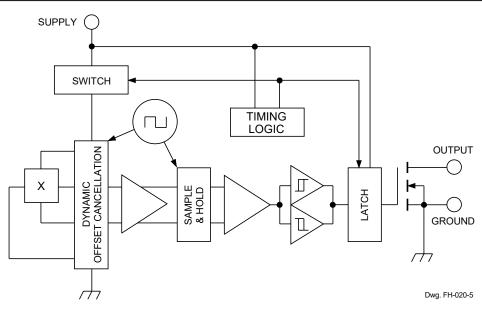
The A3211 and A3212 integrated circuits are ultrasensitive, pole independent Hall-effect switches with latched digital output. These devices are especially suited for operation in battery-operated, hand-held equipment such as cellular and cordless telephones, pagers, and palmtop computers. A 2.5 to 3.5 V operation and a unique clocking scheme reduce the average operating power requirements to less than 15 μ W with a 2.75 V supply.

Unlike other Hall-effect switches, either a north <u>or</u> south pole of sufficient strength will turn the output on in the A3212, and in the absence of a magnetic field, the output is off. The A3211 provides an inverted output. The polarity independence and minimal power requirements allow these devices to easily replace reed switches for superior reliability and ease of manufacturing, while eliminating the requirement for signal conditioning.

Improved stability is made possible through chopper stabilization (dynamic offset cancellation), which reduces the residual offset voltage normally caused by device overmolding, temperature dependencies, and thermal stress.

This device includes on a single silicon chip a Hall-voltage generator, small-signal amplifier, chopper stabilization, a latch, and a MOSFET output. Advanced CMOS processing is used to take advantage of low-voltage and low-power

Continued on next page



Functional Block Diagram

DESCRIPTION (continued)

requirements, component matching, very low input-offset errors, and small component geometries.

Four package styles provide magnetically optimized solutions for most applications. Miniature low-profile surface-mount package types EH and EL (0.75 and 0.50 mm nominal height) are leadless, LH is a 3-pin low-profile SMD, and UA is a three-pin SIP for throughhole mounting. Packages are lead (Pb) free (suffix, -T) with 100% matte-tin-plated leadframes.

SPECIFICATIONS

SELECTION GUIDE

Part Number	Packing ^[1]	Package	Ambient Temperature T _A (°C)	State in Magnetic Field
A3211EEHLT-T [2][3][4]	3000 pieces per reel	2 mm × 3 mm, 0.75 mm nominal height DFN		
A3211EELLT-T [2][4][5]	3000 pieces per reel	2 mm × 2 mm, 0.50 mm nominal height DFN	40 45 05	Off
A3211ELHLT-T ^[4]	3000 pieces per reel	3-pin surface mount SOT23W	40 to 85	Off
A3211ELHLX-T ^[4]	10000 pieces per 13-in. reel	3-pin surface mount SOT23W		
A3212EEHLT_T [2][3]	3000 pieces per reel	2 mm × 3 mm, 0.75 mm nominal height DFN		
A3212EELLT-T [2][5]	3000 pieces per reel	2 mm × 2 mm, 0.50 mm nominal height DFN		
A3212ELHLT-T	3000 pieces per reel	3-pin surface mount SOT23W	-40 to 85	
A3212ELHLX-T	10000 pieces per 13-in. reel	3-pin surface mount SOT23W	_	0-
A3212EUA-T	500 pieces per bulk bag	SIP-3 through hole	_	On
A3212LLHLT-T	3000 pieces per reel	3-pin surface mount SOT23W		
A3212LLHLX-T	10000 pieces per 13-in. reel) pieces per 13-in. reel 3-pin surface mount SOT23W -40 to 150		
A3212LUA–T	500 pieces per bulk bag	SIP-3 through hole		

¹ Contact Allegro for additional packaging and handling options.

² Allegro products sold in DFN package types are not intended for automotive applications.

³ Variant is no longer in production. The device should not be purchased for new design applications. Samples are no longer available.

Date of status change: June 1, 2015 (A3212EEHLT-T), December 1, 2015 (A3211EEHLT-T).

⁴ For automotive sales, please contact the field applications engineer.

⁵ Variant is in production but has been determined to be LAST TIME BUY. This classification indicates that the product is obsolete and notice has been given. Sale of this device is currently restricted to existing customer applications. The device should not be purchased for new design applications because of obsolescence in the near future. Samples are no longer available. Date of status change: September 1, 2016.



ABSOLUTE MAXIMUM RATINGS

Characteristic	Symbol	Notes	Rating	Units
Supply Voltage	V _{DD}		5	V
Magnetic Flux Density	В		Unlimited	G
Output Off Voltage	V _{OUT}		5	V
Output Current	I _{OUT}		1	mA
	т	Range E	-40 to 85	°C
Operating Ambient Temperature	T _A	Range L	-40 to 150	°C
Maximum Junction Temperature	T _J (max)		165	°C
Storage Temperature	T _{stg}		–65 to 170	°C

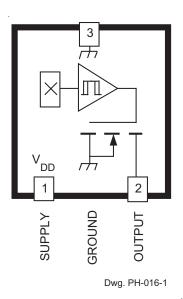


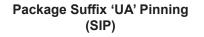
A3211 and A3212

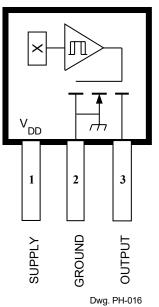
Micropower Ultrasensitive Hall-Effect Switches

PINOUT DRAWINGS

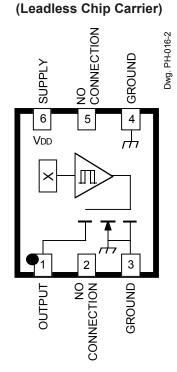
Package Suffix 'EL' Pinning (Leadless Chip Carrier)





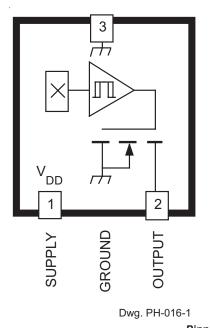


. Pinning is shown viewed from branded side.



Package Suffix 'EH' Pinning

Package Suffix 'LH' Pinning (SOT23W)





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ELECTRICAL CHARACTERISTICS: Over operating voltage and temperature range (unless otherwise specified)

Chanastaniatia	Symbol Test Conditions	Toot Conditions	Limits				
Characteristic		lest conditions	Min.	Тур.*	Max.	Units	
Supply Voltage Range	V _{DD}	Operating	2.5	2.75	3.5	V	
Output Leakage Current	I _{OFF}	V _{OUT} = 3.5 V, Output off	-	<1.0	1.0	μA	
Output On Voltage	V _{OUT}	I _{OUT} = 1 mA, V _{DD} = 2.75 V	-	100	300	mV	
Awake Time	t _{awake}		-	45	90	μs	
Period	t _{period}		-	45	90	ms	
Duty Cycle	d.c.		-	0.1	-	%	
Chopping Frequency	f _C		-	340	_	kHz	
	I _{DD(EN)}	Chip awake (enabled)	-	-	2.0	mA	
Supply Current	I _{DD(DIS)}	Chip asleep (disabled)	-	-	8.0	μA	
Supply Current		V _{DD} = 2.75 V	-	5.1	10	μA	
	IDD(AVG)	V _{DD} = 3.5 V	-	6.7	10	μA	

* Typical data is at T_{A} = 25°C and V_{DD} = 2.75 V, and is for design information only.



A3211 MAGNETIC CHARACTERISTICS: Over operating voltage range (unless otherwise specified)

Characteristic	Symbol	Test Conditions		Limits			
Characteristic Symbol		Test conditions		Тур.	Max.	Units	
Over Temperature	Over Temperature Range E: T _A = –40°C to 85°C						
Operate Points	B _{OPS}	South pole to branded side; $B > B_{OP}$, V_{OUT} = High (Output Off)	_	37	55	G	
B _{OF}	B _{OPN}	North pole to branded side; $B > B_{OP}$, $V_{OUT} = High$ (Output Off)	-55	-40	-	G	
Release Points	B _{RPS}	South pole to branded side; $B < B_{RP}$, V_{OUT} = Low (Output On)	10	31	-	G	
	B _{RPN}	North pole to branded side; B < B _{RP} , V _{OUT} = Low (Output On)	-	-34	-10	G	
Hysteresis	B _{HYS}	B _{OPx} - B _{RPx}	-	5.9	-	G	

NOTES: 1. Negative flux densities are defined as less than zero (algebraic convention), i.e., -50 G is less than +10 G.

2. B_{OPx} = operate point (output turns off); B_{Ppx} = release point (output turns on). 3. Typical Data is at T_A = +25°C and V_{DD} = 2.75 V and is for design information only. 4. 1 gauss (G) is exactly equal to 0.1 millitesla (mT).

A3212 MAGNETIC CHARACTERISTICS: Over operating voltage range (unless otherwise specified)

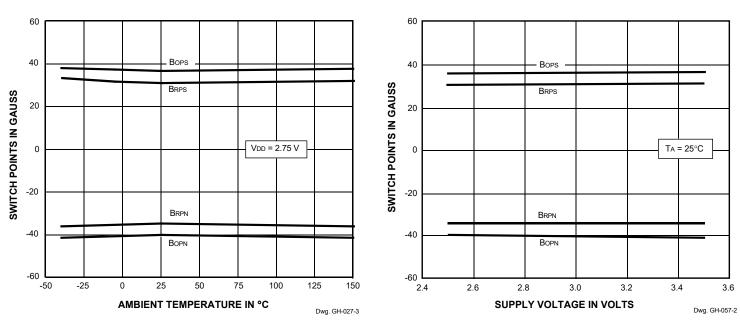
Characteristic	Querrahal	Test Ora differen	Limits			
Characteristic	Symbol	Test Conditions		Тур.	Max.	Units
Over Temperature F	Range E: T _A	= –40°C to 85°C		·	~	
Operate Points	B _{OPS}	South pole to branded side; B > B _{OP} , V _{OUT} = Low (Output On)	_	37	55	G
Operate Points	B _{OPN}	North pole to branded side; $B > B_{OP}$, $V_{OUT} = Low$ (Output On)	-55	-40	_	G
Release Points	B _{RPS}	South pole to branded side; $B < B_{RP}$, V_{OUT} = High (Output Off)	10	31	_	G
B _{RPN}	B _{RPN}	North pole to branded side; $B < B_{RP}$, V_{OUT} = High (Output Off)	-	-34	-10	G
Hysteresis	B _{HYS}	B _{OPx} - B _{RPx}		5.9	_	G
Over Temperature Range L: T _A = -40°C to 150°C						
Operate Deinte	B _{OPS}	South pole to branded side; B > B _{OP} , V _{OUT} = Low (Output On)	_	37	65	G
Operate Points	B _{OPN}	North pole to branded side; B > B _{OP} , V _{OUT} = Low (Output On)	-65	-40	_	G
Release Points	B _{RPS}	South pole to branded side; B < B _{RP} , V _{OUT} = High (Output Off)	10	31	_	G
	B _{RPN}	North pole to branded side; B < B _{RP} , V _{OUT} = High (Output Off)	_	-34	-10	G
Hysteresis	B _{HYS}	B _{OPx} - B _{RPx} –		5.9	-	G

NOTES: 1. Negative flux densities are defined as less than zero (algebraic convention), i.e., -50 G is less than +10 G.

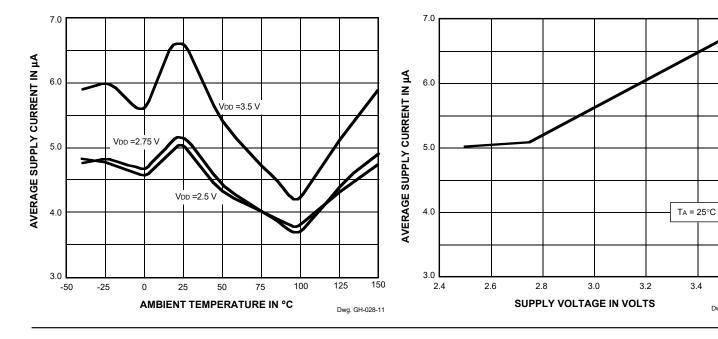
2. B_{OPx} = operate point (output turns on); B_{Ppx} = release point (output turns off). 3. Typical Data is at T_A = +25°C and V_{DD} = 2.75 V and is for design information only. 4. 1 gauss (G) is exactly equal to 0.1 millitesla (mT).



TYPICAL OPERATING CHARACTERISTICS



Switch Points



Supply Current



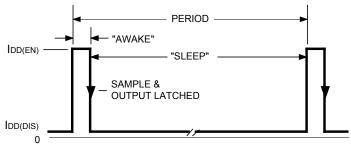
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Dwg. GH-058-7

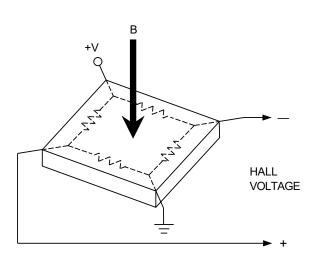
FUNCTIONAL DESCRIPTION

Low Average Power

Internal timing circuitry activates the IC for 45 μ s and deactivates it for the remainder of the period (45 ms). A short "awake" time allows for stabilization prior to the sampling and data latching on the falling edge of the timing pulse. The output during the "sleep" time is latched in the last sampled state. The supply current is not affected by the output state.



Dwg. WH-017-2

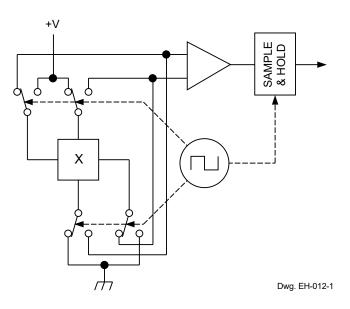




Chopper-Stabilized Technique

The Hall element can be considered as a resistor array similar to a Wheatstone bridge. A large portion of the offset is a result of the mismatching of these resistors. These devices use a proprietary dynamic offset cancellation technique, with an internal high-frequency clock to reduce the residual offset voltage of the Hall element that is normally caused by device overmolding, temperature dependencies, and thermal stress. The chopper-stabilizing technique cancels the mismatching of the resistor circuit by changing the direction of the current flowing through the Hall plate using CMOS switches and Hall voltage measurement taps, while maintaing the Hall-voltage signal that is induced by the external magnetic flux. The signal is then captured by a sample-and-hold circuit and further processed using low-offset bipolar circuitry. This technique produces devices that have an extremely stable quiescent Hall output voltage, are immune to thermal stress, and have precise recoverability after temperature cycling. A relatively high sampling frequency is used for faster signal processing capability can be processed.

More detailed descriptions of the circuit operation can be found in: Technical Paper STP 97-10, *Monolithic Magnetic Hall Sensing Using Dynamic Quadrature Offset Cancellation* and Technical Paper STP 99-1, *Chopper-Stabilized Amplifiers With A Track-and-Hold Signal Demodulator*.





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Operation

The output of the A3212 switches low (turns on) when a magnetic field perpendicular to the Hall element exceeds the operate point B_{OPS} (or is less than B_{OPN}). After turn-on, the output is capable of sinking up to 1 mA and the output voltage is $V_{OUT(ON)}$. When the magnetic field is reduced below the release point B_{RPS} (or increased above B_{RPN}), the device output switches high (turns off). The difference in the magnetic operate and release points is the hysteresis (B_{hys}) of the device. This built-in hysteresis allows clean switching of the output even in the presence of external mechanical vibration and electrical noise. The A3211 functions in the same manner, except the output voltage is reversed from the A3212, as shown in the figures to the right.

As used here, negative flux densities are defined as less than zero (algebraic convention), i.e., -50 G is less than +10 G.

Applications

Allegro's pole-independent processing technique allows for operation with either a north pole or south pole magnet orientation, enhancing the manufacturability of the device. The state-of-theart technology provides the same output polarity for either pole face.

It is strongly recommended that an external bypass capacitor be connected (in close proximity to the Hall element) between the supply and ground of the device to reduce both external noise and noise generated by the chopper-stabilization technique. This is especially true due to the relatively high impedance of battery supplies.

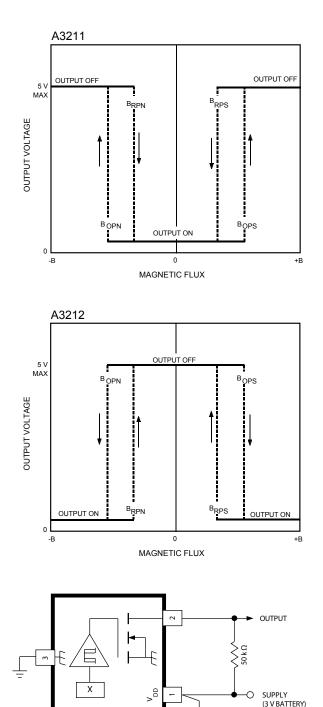
The simplest form of magnet that will operate these devices is a bar magnet with either pole near the branded surface of the device. Many other methods of operation are possible. Extensive applications information for Hall-effect devices is available in: • *Hall-Effect IC Applications Guide*, Application Note 27701; • *Hall-Effect Devices: Guidelines for Designing Subassemblies*

Using Hall-Effect Devices, Application Note 27703.1;

• Soldering Methods for Allegro's Products — SMD and Through-Hole, Application Note 26009.

All are provided at

www.allegromicro.com

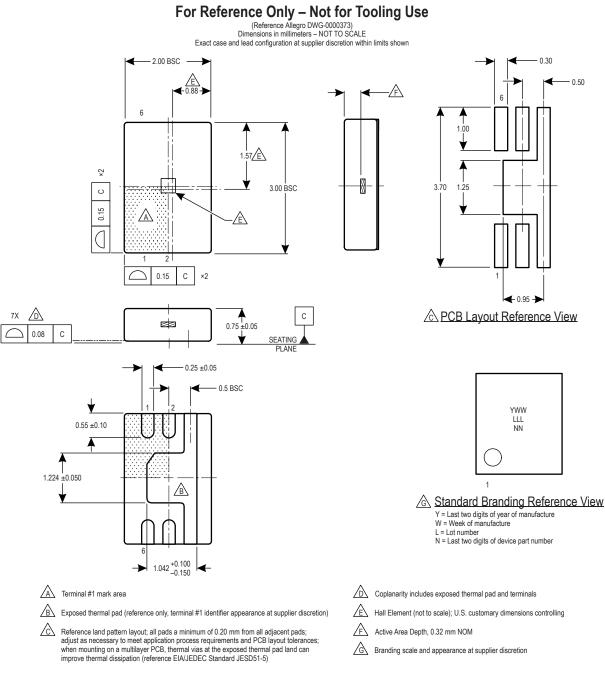


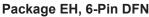


0.1 μF

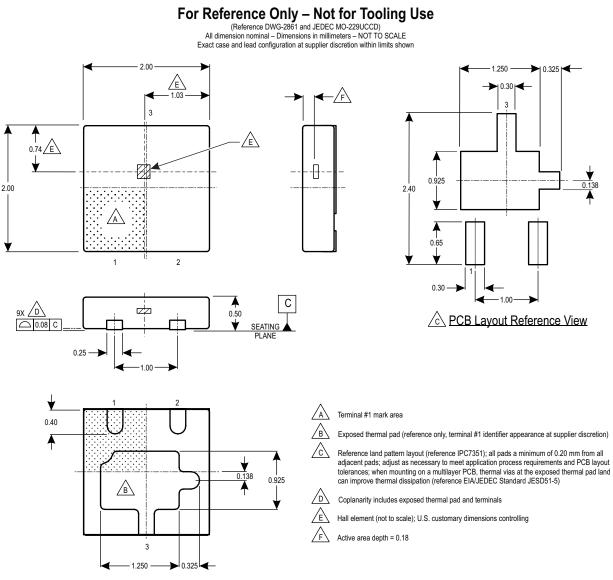
Dwg. EH-013-2

PACKAGE OUTLINE DRAWINGS



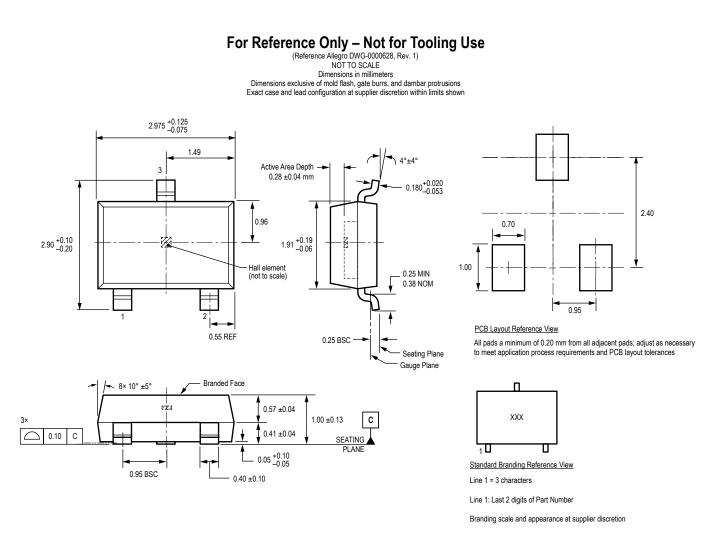






Package EL, 3-Pin DFN



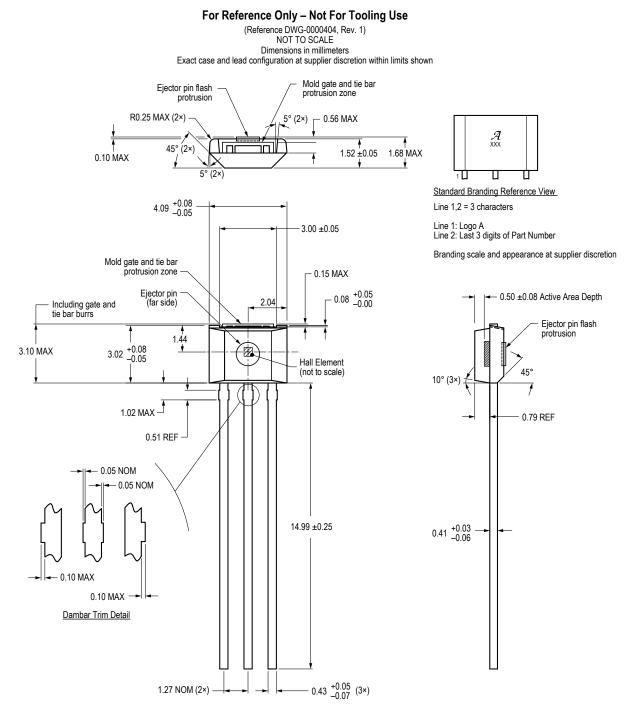


Package LH, 3-Pin SOT-23W



A3211 and A3212

Micropower Ultrasensitive Hall-Effect Switches



Package UA, 3-Pin SIP



Revision History

Number	Date	Description
18	December 11, 2013	Update application note references
19	August 1, 2014	Revised footnote on Selection Guide
20	January 1, 2015	Added LX option to Selection Guide
21	September 22, 2015	Corrected LH package Active Area Depth value; added AEC-Q100 qualification under Features and Benefits
22	December 1, 2015	Updated product status in Selection Guide and footnotes
23	December 5, 2016	Updated product status in Selection Guide and footnotes
24	February 27, 2017	Minor editorial updates
25	February 19, 2019	Minor editorial updates
26	February 24, 2020	Minor editorial updates
27	February 16, 2022	Updated package drawings (pages 9, 11-12)

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